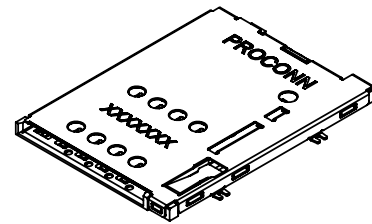


機密文件

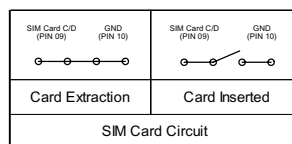
REV.	MODIFICATION	DRAWN	APPROVED

- NOTES :
- MATERIAL :**
Housing/Slide : High temperature thermoplastic,UL94-V0.
Housing Color : Black
Slide Color : Ivory
Terminal & C/D PIN: Copper Alloy.
Cover : Stainless.
Hook/Spring : Stainless.
 - Finish :**
Terminal :
Underplate : Ni over all.
Solder tail : Au over Ni plate.
Contact Area : Au over Ni plate.
C/D PIN : Au over all
GND PIN :
Underplate : Ni over all.
Solder tail : Au over Ni plate.
Contact Area : Au over Ni plate.
Cover :
Solder tail : Au over all.
 - There can't be things to press and hold on the products surface
 - P/N : S P P N 0 8 - X 0 - 5 0 0 0

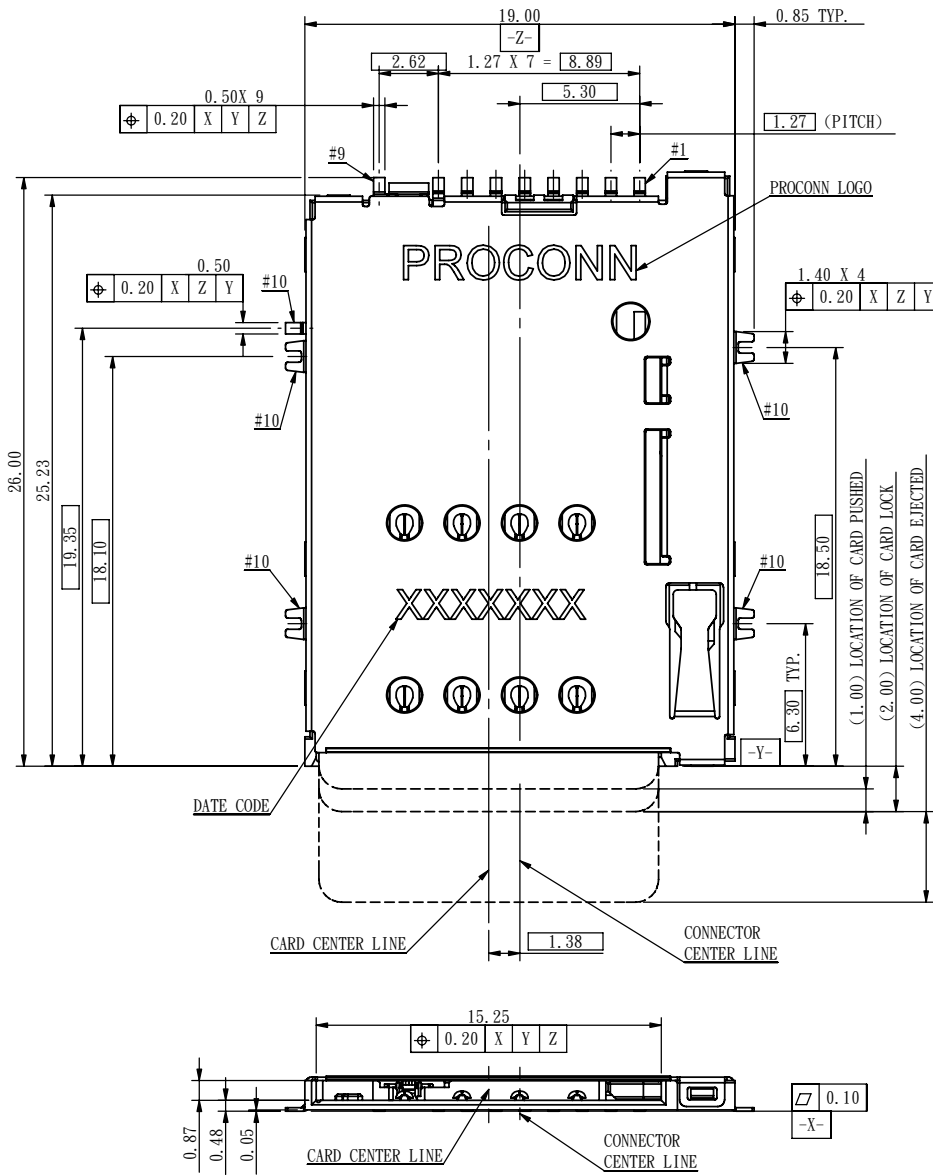
A: GOLD FLASH
D: 15u" GOLD





GENERAL TOLERANCE		Proconn Technology Co., Ltd.	
X±0.40	X°±5°		
.X±0.30	.X°±2°		
.XX±0.20	.XX°±1°		
.XXX±0.10	.XXX°±0.5°	TITLE SIM CARD CONNECTOR PUSH TYPE (1.5mm)	
CUSTOMER DRAWING		PART NO. SPPN08-X0-5000	DWG NO. SPPN08-07-A
APPROVAL Tony	CHECKED 张纬	DRAWN 张纬	UNIT mm
		SCALE NONE	SHEET 1 / 3
		PROJ. A	REV. A

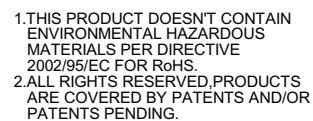


1.THIS PRODUCT DOESN'T CONTAIN ENVIRONMENTAL HAZARDOUS MATERIALS PER DIRECTIVE 2002/95/EC FOR RoHS.
2.ALL RIGHTS RESERVED,PRODUCTS ARE COVERED BY PATENTS AND/OR PATENTS PENDING.



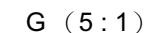


 : SOLDER AREA
 : PATTERN PROHIBITED AREA



PMS-B06-11(A)



A
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B
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C
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D
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E
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F
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G
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H
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I
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J



G





GENERAL TOLERANCE	
$X \pm 0.40$	$X.^{\circ} \pm 5^{\circ}$
$.X \pm 0.30$	$.X.^{\circ} \pm 2^{\circ}$
$.XX \pm 0.20$	$.XX.^{\circ} \pm 1^{\circ}$
$.XXX \pm 0.10$	$.XXX.^{\circ} \pm 0.5^{\circ}$

APPROVAL 	CHECKED 
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TITLE	SIM CARD CONNECTOR PUSH TYPE (1.5mm)
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DWG NO.	SPPN08-07-A
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DRAWN 	UNIT mm	SCALE NONE	SHEET 3 / 3
		PROJ. 	REV. A

A
B
C
D
E
F
G
H
I
J

